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Docket No.: SUN-0074

11-23-2004

COVER SHEET

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Record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Ki-Sung Kim
Chang-Hwan Hwang
Yoon-Young Cho

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment

☐ Merger

☐ Security Agreement

☐ Change of Name

☐ Other

Execution Date: **October 15, 2004**

2. Name and address of receiving party(ies):

Name: **SAMSUNG ELECTRONICS CO., LTD.**

Address: **416, Maetan-dong, Yeongtong-gu**

Suwon-si, Gyeonggi-do, Republic of Korea

City: _____ State/Prov.: _____

Country: _____ ZIP: _____

Additional name(s) & address(es)

☐ Yes ☒ No

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is: **October 15, 2004**

Patent Application No.

Filing date

B. Patent No.(s)

Additional numbers

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **Jae Y. Park**

Registration No. (see attached)

Address: **Cantor Colburn LLP**

55 Griffin Road South

11/22/2004 EDOOPER 00000279 061130 29217184

01 FC:8021 40.00 DA

City: **Bloomfield** State/Prov.: **CT**

Country: **USA** ZIP: **06002**

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ **40.00**

☐ Enclosed - Any excess or insufficiency should be credited or debited to deposit account

☒ Authorized to be charged to deposit account

8. Deposit account number:

06-1130

(Attach duplicate copy of this page if paying by deposit account)

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Jae Y. Park

Name of Person Signing

Signature

November 15, 2004

Date

Total number of pages including cover sheet, attachments, and

3

ASSIGNMENT

WHEREAS We, **KI-SUNG KIM** of **402, Samsung Billa, 572-105, Seongsan-dong, Mapo-gu Seoul, Rep. of Korea**, **CHANG-HWAN HWANG** of **536-1301, Eunbit-maeul Samsung Apt., Hwajeong-dong, Dukyang-gu, Goyang-si, Gyeonggi-do, Rep. of Korea** and **YOON-YOUNG CHO** of **308-603, Jugong Apt., 688, Deungchon-dong, Gangseo-gu, Seoul, Rep. of Korea** (hereinafter referred to as “**ASSIGNORS**”) have invented certain new and useful improvements in:

CELLULAR PHONE

and for which We have filed an application for Letters Patent of the United States on 2004 (Serial No. _____);

AND WHEREAS, **SAMSUNG ELECTRONICS CO., LTD.** (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Korea, having a place of business at **416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea**, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 2004. 10. 15 Ki-Sung Kim L.S.
KI-SUNG KIM

Date: 2004. 10. 15 Chang Hwan L.S.
CHANG-HWAN HWANG

Date: 2004. 10. 15 Yoon Young Cho L.S.
YOON-YOUNG CHO